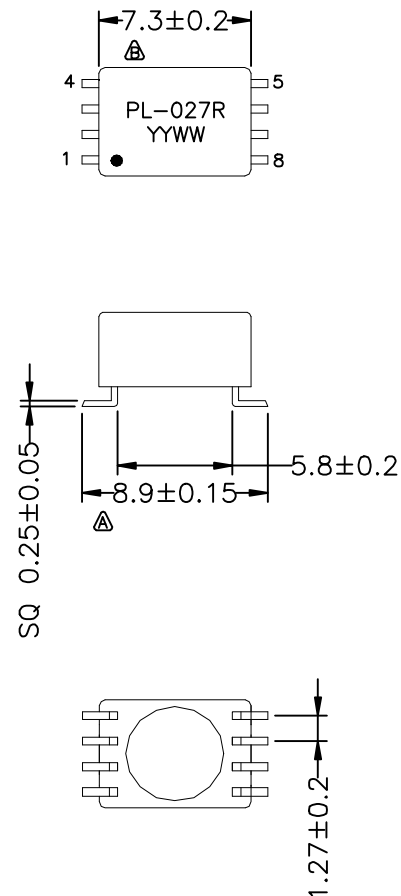
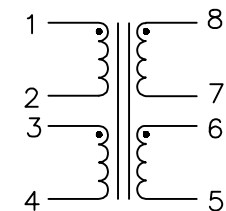


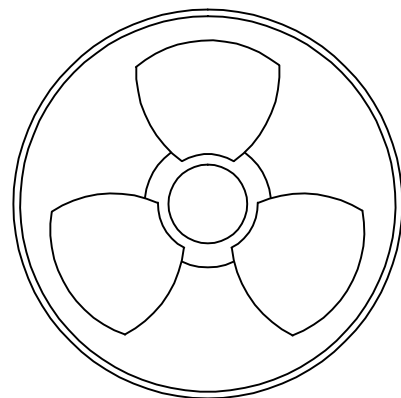
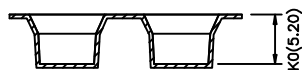
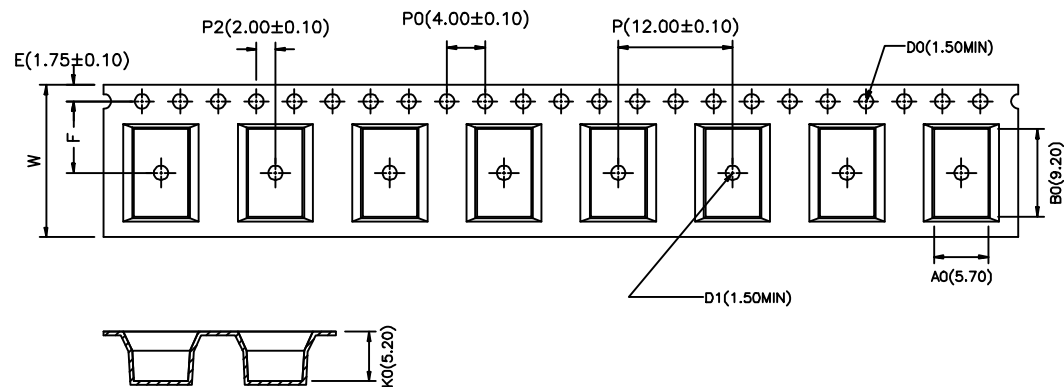
UNIT:mm



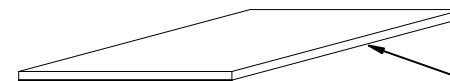
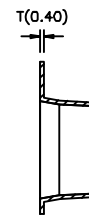
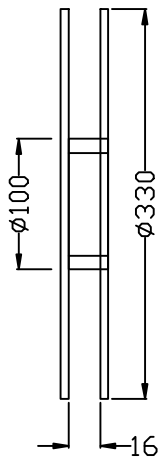
ELECTRICAL CHARACTERISTICS :

1. DCR : PIN 1-2 = 120mΩ MAX.
PIN 3-4 = 120mΩ MAX.
PIN 8-7 = 120mΩ MAX.
PIN 6-5 = 120mΩ MAX.
2. INDUCTANCE (@10KHz, 0.1Vrms)
PIN 1-4 (PIN 2-3 SHORT) = 23uH MIN.
3. LEAKAGE INDUCTANCE (@100KHz, 0.1Vrms)
PIN 1-4 (PIN 2-3,5-6-7-8 SHORT) = 0.6uH MAX.
4. INTERWINDING CAPACITANCE (@100KHz, 0.1Vrms)
PIN 1-8 (PIN 2-3,6-7 SHORT) = 20pF MAX.
5. TURN RATIO (@100KHz, 0.1Vrms)
PIN 1-2 : 3-4 : 8-7 : 6-5 = 1:1:1:1 ±2%
6. HI-POT (@3000VAC, 1mA, 60Sec)
PIN 1-8 (PIN 2-3,6-7 SHORT)
7. OPERATING TEMPERATURE RANGE : -40°C~+85°C
8. RoHS COMPLIANT

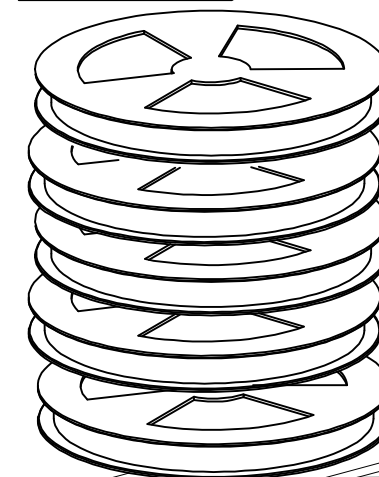
D	CHANGE ELECTRICAL CHARACTERISTICS	09/07/2015	SHIRLEY	RONAN	RONAN		TITLE	
C	CHANGE DIM.	11/16/2012	SHIRLEY	RONAN	RONAN		DWG. NO. PL-027R	
B	CHANGE ELECTRICAL CHARACTERISTICS & LOGO PRINT	07/09/2012	SHIRLEY	BETTY	BETTY			
	RELEASE	03/05/2012	SHIRLEY	RONAN	RONAN	UNITS: M/M	SAFETY	SHEET 1 of 1
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE 03/05/12	P/N:	DRAW SHIRLEY
REVISIONS								



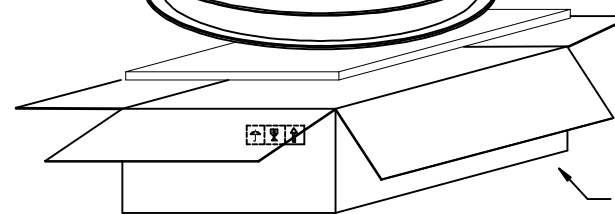
REEL



3240300009 or
3240300001
PK-045*2
(SPONGE)



3260160000
(REEL) * 5PCS



PK-071*1PCS
(CARTON)
3213432100

每捲放乾燥包1pcs 用真空袋抽真空封口
2780000000 3255048421 or 3255048420

ITEM	W	Ao	Bo	Ko	P	F	E	D0	D1	Po	P2	T
DIM	16.00 ^{+0.30} _{-0.10}	5.70 ^{+0.10} _{-0.10}	9.20 ^{+0.10} _{-0.10}	5.20 ^{+0.10} _{-0.10}	12.0 ^{+0.10} _{-0.10}	7.50 ^{+0.10} _{-0.10}	1.75 ^{+0.10} _{-0.10}	1.50 ^{+0.10} _{-0.00}	1.50 ^{+0.25} _{-0.00}	4.00 ^{+0.10} _{-0.10}	2.00 ^{+0.10} _{-0.10}	0.40 ^{+0.05} _{-0.05}



載帶前空24格, 後空24格

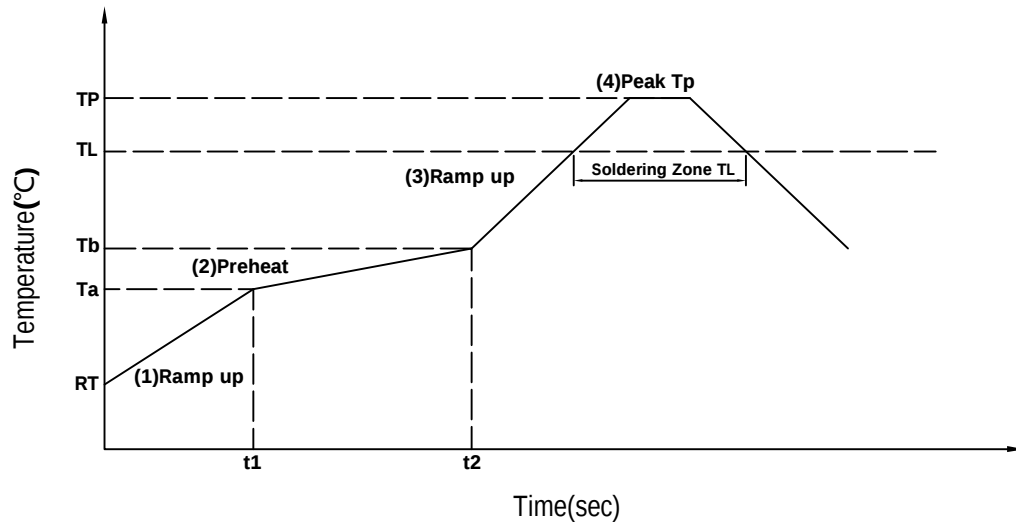
ONE REEL 1000 PCS

ONE CARTON 5 REEL (5000 PCS)

C	ADD SPEC.	01/23/2014	SHIRLEY	JOAN	JOAN		TITLE		PACKING
B	CHANGE PACKING TYPE	01/15/2014	SHIRLEY	JOAN	JOAN		DWG. NO.		968PL02700
A	CHANGE QUANTITY	08/18/2012	SHIRLEY	RONAN	RONAN				
	RELEASE	07/03/2012	SHIRLEY	JOAN	JOAN	UNITS:	SAFETY		SHEET 1 of 1
NO:	DESCRIPTION	DATE	BY	CHK	APPD	M/M	P/N:		DRAW
REVISIONS						07/03/12			Shirley



Pb-free Soldering IR Reflow(SMD)



- 1,MSL Grade: 1 Level 2,Floor life: 2years 3,Condition:≤30°C RH 85%
2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

IR reflow profile		Pb-free
step#	Profile Feature	Condition/Duration
step1	Ramp-up rate	3°C/second max
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds
step3	Ramp-up rate(TL to Tp)	3°C/second max
	Temperature maintained above 217°C	60-150seconds
step4	Peak temperature(Tp)	260+0/-5°C
	Time within 5°C of actual peak temperature	30seconds max
Ramp-down rate(Tp to TL)		6°C/second max

- 3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5°C
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5°C
>2.5mm	250+0/-5°C	245+0/-5°C	245+0/-5°C